

PCT

WORLD INTELLECTUAL PROPERTY ORGANIZATION
International Bureau



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(51) International Patent Classification 6: C25D 9/04	A1	(11) International Publication Number: WO 98/33960	(43) International Publication Date: 6 August 1998 (06.08.98)
--	----	---	--

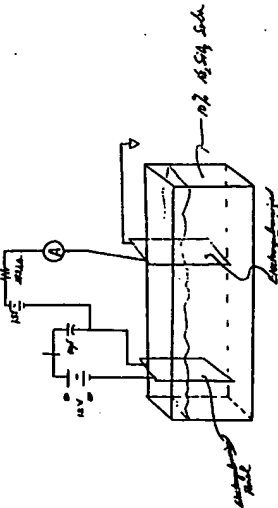
(21) International Application Number: PCT/US98/01682	(81) Designated States: AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, DR, ES, FI, GB, GR, GH, HU, IL, IS, JP, KE, KG, KP, KR, KZ, LC, LI, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, MY, NZ, PL, PT, RO, RU, SD, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZW, AR, JP, AU, PT, BR, KE, LS, MW, SD, SZ, UG, ZW, European patent (AM, AZ, BY, KG, KZ, RU, TJ, TM), European patent (AT, BE, CH, DE, DK, ES, FI, FR, GB, GR, IE, IT, LI, MC, NL, PT, SD, OAPI) patent (BP, BI, CF, CG, CI, CM, GA, GN, ML, MR, NE, SN, TD, TO).
--	--

(70) Inventors; and
(75) Inventors/Applicants (for US only): HERMANN, Robert, L. [US/US]; 1 Circle Drive, Moberly, MO 65770 (US); DALTON, William, M. [US/US]; 577 W. Carpenter Street, Moberly, MO 65770 (US); HAHN, John [US/US]; 4404 Derby Ridge Drive, Columbia, MO 65202 (US); PRICE, David, L. [US/US]; 1314 Woodhige, Moberly, MO 65770 (US).

(71) Applicant (for all designated States except US): ELISHA TECHNOLOGIES CO. L.L.C. [US/US]; 2000 US Highway 63 South, Moberly, MO 65770 (US).

(74) Agent: BOYER, Michael, Kevin; Orscheln Management Co., 2000 US Highway 63 South, Moberly, MO 65770 (US).

(54) Title: AN ELECTROLYTIC PROCESS FOR FORMING A MINERAL CONTAINING COATING



(57) Abstract

The disclosure relates to a process for forming a deposit on the surface of a metallic or conductive surface. The process employs an electrolytic process to deposit a mineral containing coating or film upon a metallic or conductive surface.

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT:

AL	Albania	ES	Spain	LS	Lesotho	SI	Slovenia
AM	Armenia	FI	Finland	LT	Lithuania	SK	Slovakia
AT	Austria	FR	France	LJ	Luxembourg	SN	Senegal
AU	Australia	GB	United Kingdom	LV	Latvia	SZ	Swaziland
AZ	Azerbaijan	GR	Greece	MC	Monaco	TD	Togo
BA	Bosnia and Herzegovina	HR	Croatia	MD	Moldova	TG	Togo
BB	Barbados	IE	Ireland	ME	Montenegro	TM	Turkmenistan
BE	Belgium	IL	Israel	MK	Republic of Macedonia	TT	Trinidad and Tobago
BG	Bulgaria	IN	India	ML	Mali	UA	Ukraine
BR	Brazil	IS	Iceland	MN	Mongolia	UG	Uganda
BY	Belarus	IT	Italy	MR	Mauritania	US	United States of America
CA	Canada	JP	Japan	MW	Malawi	UZ	Uzbekistan
CG	Congo	KE	Kenya	MX	Mexico	VN	Viet Nam
CH	Switzerland	KG	Kyrgyzstan	NI	Nicaragua	YU	Yugoslavia
CI	Cote d'Ivoire	KZ	Kazakhstan	NO	Norway	ZW	Zimbabwe
CM	Cameroun	KR	Republic of Korea	NZ	New Zealand		
CN	China	LA	Laos	PL	Poland		
CU	Cuba	LC	St. Lucia	PT	Portugal		
CZ	Czech Republic	LT	Lithuania	RO	Romania		
DE	Germany	LU	Luxembourg	RU	Russian Federation		
DK	Denmark	LV	Latvia	SE	Sweden		
EE	Estonia	UA	Ukraine	SG	Singapore		

TITLE

AN ELECTROLYTIC PROCESS FOR FORMING A MINERAL CONTAINING COATING

The subject matter of this invention claims benefit under 35 U.S.C. 111(a), 35 U.S.C. 119(e) and 35 U.S.C. 120 of U.S. Provisional Patent Application Serial Nos. 60/036,024, filed on January 31, 1997 and Serial No. 60/045,446, filed on May 2, 1997 and entitled "Non-Equilibrium Enhanced Mineral Deposition". The disclosure of the previously filed provisional patent applications is hereby incorporated by reference.

FIELD OF THE INVENTION

The instant invention relates to a process for forming a deposit on the surface of a metallic or conductive surface. The process employs an electrolytic process to deposit a mineral containing coating or film upon a metallic or conductive surface.

BACKGROUND OF THE INVENTION

Silicates have been used in electrocleaning operations to clean steel, tin, among other surfaces. Electrocleaning is typically employed as a cleaning step prior to an electroplating operation. Using "Silicates As Cleaners In The Production of Tinplate" is described by L.J. Brown in February 1966 edition of *Plating*.

Processes for electrolytically forming a protective layer or film by using an anodic method are disclosed by U.S. Patent No. 3,658,662 (Casson, Jr. et al.), and United Kingdom Patent No. 498,485; both of which are hereby incorporated by reference.

U.S. Patent No. 5,352,342 to Riffe, which issued on October 4, 1994 and is entitled "Method And Apparatus For Preventing Corrosion Of Metal Structures" that describes using electromotive forces upon a zinc solvent containing paint.

SUMMARY OF THE INVENTION

The instant invention solves problems associated with conventional practices by providing a cathodic method for forming a protective layer upon a metallic substrate. The cathodic method is normally conducted by immersing a electrically conductive substrate into a silicate containing bath wherein a current is passed through the bath and the substrate is the cathode. A mineral layer comprising an amorphous matrix surrounding or incorporating metal silicate crystals forms upon the substrate. The mineral layer imparts improved corrosion resistance, among other properties, to the underlying substrate.

The inventive process is also a marked improvement over conventional methods by obviating the need for solvents or solvent containing systems to form a corrosion resistant layer, i.e., a mineral layer. In contrast, to conventional methods the inventive process is substantially solvent free. By "substantially solvent free" it is meant that less than about 5 wt.%, and normally less than about 1 wt.% volatile organic compounds (V.O.C.s) are present in the electrolytic environment.

In contrast to conventional electrocleaning processes, the instant invention employs silicates in a cathodic process for forming a mineral layer upon the substrate. Conventional electrocleaning processes sought to avoid formation of oxide containing products such as greenalite whereas the instant invention relates to a method for forming silicate containing products, i.e., a mineral.

CROSS REFERENCE TO RELATED PATENTS AND PATENT APPLICATIONS

The subject matter of the instant invention is related to copending and commonly assigned Non-Provisional U.S. Patent Application Serial Nos. 08/850,323; 08/850,586; and _____ (EL001RH-6, EL001RH-7 and EL001RH-8), filed respectively on May 2, 1997 and even date herewith, and 08/791,337 (Attorney Docket No. EL001RH-4 filed on January 31, 1997) in the names of Robert L. Heilmann et al., as a continuation in part of Serial No. 08/634,215 (filed on April 18, 1996) in the names of Robert L. Heilmann et al., and entitled "Corrosion Resistant Buffer System for Metal Products", which is a continuation in part of Non-Provisional U.S. Patent Application Serial No. 08/476,271 (filed on June 7, 1995) in the names of Heilmann et al., and corresponding to WIPO Patent Application Publication No. WO 96/12770, which in turn is a continuation in part of Non-Provisional U.S. Patent Application Serial No. 08/327,438 (filed on October 21, 1994), now allowed.

The subject matter of this invention is related to Non-Provisional Patent Application Serial No. _____ (Attorney Docket No. EL004RH-1), filed on even date herewith and entitled "Corrosion Protective Coatings". The subject matter of this invention is also related to Non-Provisional Patent Application Serial No. _____ (Attorney Docket No. EL005NM-1), filed respectively, on even date herewith and January 31, 1997 and entitled "Aqueous Gel Compositions and Use Thereof". The disclosure of the previously identified patents, patent applications and publications is hereby incorporated by reference.

BRIEF DESCRIPTION OF THE DRAWING

Figure 1 is a schematic drawing of the circuit and apparatus which can be employed for practicing an aspect of the invention.

DETAILED DESCRIPTION

The instant invention relates to a process for depositing or forming a mineral containing coating or film upon a metallic or an electrically conductive surface. The process employs a mineral containing solution e.g., containing soluble mineral components, and utilizes an electrically enhanced method to obtain a mineral coating or film upon a metallic or conductive surface. By "mineral containing coating," it is meant to refer to a relatively thin coating or film which is formed upon a metal or conductive surface wherein at least a portion of the coating or film includes at least one of metal atom containing mineral, e.g., an amorphous phase or matrix surrounding or incorporating crystals comprising a zinc disilicate. Mineral and Mineral Containing are defined in the previously identified Copending and Commonly Assigned Patents and Patent Applications; incorporated by reference. By "electrolytic" or "electrodeposition" or "electrically enhanced", it is meant to refer to an environment created by passing an electrical current through a silicate containing medium while in contact with an electrically conductive substrate wherein the substrate functions as the cathode.

The electrolytic environment can be established in any suitable manner including immersing the substrate, applying a silicate containing coating upon the substrate and thereafter applying an electrical current, among others. The preferred method for establishing the environment will be determined by the size of the substrate, electroplating time, among other parameters known in the electrodeposition art.

The silicate containing medium can be a fluid bath, gel, spray, among other methods for contacting the substrate with the silicate medium. Examples of the silicate medium comprise a bath containing at least one alkali silicate, a gel comprising at least one alkali silicate and a thickener, among others. Normally, the medium comprises a bath of sodium silicate.

The metal surface refers to a metal article as well as a non-metallic or an electrically conductive member having an adhered metal or conductive layer. Examples of suitable metal surfaces comprise at least one member selected from the group consisting of galvanized surfaces, zinc, iron, steel, brass, copper, nickel, tin, aluminum, lead, cadmium, magnesium, alloys thereof, among others. While the inventive process can be employed to coat a wide range of metal surfaces, e.g., copper, aluminum and ferrous metals, the mineral layer can be formed on a non-conductive substrate having at least one surface coated with an electrically conductive material, e.g., a ceramic material encapsulated within a metal. Conductive surfaces can also include carbon or graphite as well as conductive polymers (polyaniline for example).

The mineral coating can enhance the surface characteristics of the metal or conductive surface such as resistance to corrosion, protect carbon (fibers for example) from oxidation and improve bonding strength in composite materials,

and reduce the conductivity of conductive polymer surfaces including potential application in sandwich type materials.

In an aspect of the invention, an electrogalvanized panel, e.g., a zinc surface, is coated electrolytically by being placed into an aqueous sodium silicate solution. After being placed into the silicate solution, a mineral coating or film containing silicates is deposited by using low voltage and low current.

In one aspect of the invention, the metal surface, e.g., zinc, steel or lead, has been pretreated. By "pretreated" it is meant to refer to a batch or continuous process for conditioning the metal surface to clean it and condition the surface to facilitate acceptance of the mineral or silicate containing coating e.g., the inventive process can be employed as a step in a continuous process for producing corrosion resistant coil steel. The particular pretreatment will be a function of composition of the metal surface and desired composition of mineral containing coating/film to be formed on the surface. Examples of suitable pretreatments comprise at least one of cleaning, activating, and rinsing. A suitable pretreatment process for steel comprises:

- 1) 2 minute immersion in a 3:1 dilution of Metal Prep 79 (Parker Archem),
- 2) two deionized rinses,
- 3) 10 second immersion in a pH 14 sodium hydroxide solution,
- 4) remove excess solution and allow to air dry,
- 5) 5 minute immersion in a 50% hydrogen peroxide solution,
- 6) remove excess solution and allow to air dry.

In another aspect of the invention, the metal surface is pretreated by anodically cleaning the surface. Such cleaning can be accomplished by immersing the work piece or substrate into a medium comprising silicates, hydroxides, phosphates and carbonates. By using the work piece as the anode in a DC cell and maintaining a current of 100mA/cm², this process can generate oxygen gas. The oxygen gas agitates the surface of the workpiece while oxidizing the substrate's surface.

In a further aspect of the invention, the silicate solution is modified to include one or more dopant materials. While the cost and handling characteristics of sodium silicate are desirable, at least one member selected from the group of water soluble salts and oxides of tungsten, molybdenum, chromium, titanium, zircon, vanadium, phosphorus, aluminum, iron, boron, bismuth, gallium, tellurium, germanium, antimony, niobium (also known as columbium), magnesium and manganese, mixtures thereof, among others, and usually, salts and oxides of aluminum and iron can be employed along with or instead of a silicate. The dopant materials can be introduced to the metal or conductive surface in pretreatment steps prior to electrodeposition, in post treatment steps following electrodeposition, and/or by alternating electrolytic dips in solutions of dopants

and solutions of silicates if the silicates will not form a stable solution with the water soluble dopants. When sodium silicate is employed as a mineral solution, desirable results can be achieved by using N grade sodium silicate supplied by Philadelphia Quartz (PQ) Corporation. The presence of dopants in the mineral solution can be employed to form tailored mineral containing surfaces upon the metal or conductive surface, e.g., an aqueous sodium silicate solution containing aluminate can be employed to form a layer comprising oxides of silicon and aluminum.

The silicate solution can also be modified by adding water soluble polymers, and the electrodeposition solution itself can be in the form of a flowable gel consistency. A suitable composition can be obtained in an aqueous composition comprising 3 wt% N-grade Sodium Silicate Solution (PQ Corp), 0.5 wt% Carbopol EZ-2 (BF Goodrich), about 5 to 10 wt.% fumed silica, mixtures thereof, among others. Further, the aqueous silicate solution can be filled with a water dispersible polymer such as polyurethane to electro deposit a mineral-polymer composite coating. The characteristics of the electrodeposition solution can be modified or tailored by using an anode material as a source of ions which can be available for codeposition with the mineral anions and/or one or more dopants. The dopants can be useful for building additional thickness of the electrodeposited mineral layer.

The following sets forth the parameters which may be employed for tailoring the inventive process to obtain a desirable mineral containing coating:

1. Voltage
2. Current Density
3. Apparatus or Cell Design
4. Deposition Time
5. Concentration of the N-grade sodium silicate solution
7. Type and concentration of anions in solution
8. Type and concentration of cations in solution
9. Composition of the anode
10. Composition of the cathode
11. Temperature
12. Pressure
13. Type and Concentration of Surface Active Agents

The specific ranges of the parameters above depend on the substrate to be deposited on and the intended composition to be deposited. Items 1, 2, 7, and 8 can be especially effective in tailoring the chemical and physical characteristics of the coating. That is, items 1 and 2 can affect the deposition time and coating thickness whereas items 7 and 8 can be employed for introducing dopants that impart desirable chemical characteristics to the coating. The differing types of anions and

cations can comprise at least one member selected from the group consisting of Group I metals, Group II metals, transition and rare earth metal oxides, oxyanions such as mineral, molybdate, phosphate, titanate, boron nitride, silicon carbide, aluminum nitride, silicon nitride, mixtures thereof, among others.

While the above description places particular emphasis upon forming a mineral containing layer upon a metal surface, the inventive process can be combined with or replace conventional metal finishing practices. The inventive mineral layer can be employed to protect a metal finish from corrosion thereby replacing conventional phosphating process, e.g., in the case of automotive metal finishing the inventive process could be utilized instead of phosphates and chromates and prior to coating application e.g., E-Coat. Further, the aforementioned aqueous mineral solution can be replaced with an aqueous polyurethane based solution containing soluble silicates and employed as a replacement for the so-called automotive E-coating and/or powder painting process. Moreover, depending upon the dopants and concentration thereof present in the mineral deposition solution, the inventive process can produce enhanced electrical and corrosion resistance, or to resist ultraviolet light and monatomic oxygen containing environments such as space.

The inventive process can be employed in a virtually unlimited array of end-uses such as in conventional plating operations as well as being adaptable to field service. For example, the inventive mineral containing coating can be employed to fabricate corrosion resistant metal products that conventionally utilize zinc as a protective coating, e.g., automotive bodies and components, grain silos, bridges, among many other end-uses.

The x-ray photoelectron spectroscopy (ESCA) data in the following Examples demonstrate the presence of a unique metal disilicate species within the mineralized layer, e.g., ESCA measures the binding energy of the photoelectrons of the atoms present to determine bonding characteristics.

The following Examples are provided to illustrate certain aspects of the invention and it is understood that such an Example does not limit the scope of the invention as defined in the appended claims.

EXAMPLE 1

The following apparatus and materials were employed in this Example:

- Standard Electrogalvanized Test Panels, ACT Laboratories
- 10% (by weight) N-grade Sodium Mineral solution
- 12 Volt EverReady battery
- 1.5 Volt Ray-O-Vac Heavy Duty Dry Cell Battery
- Triplet RMS Digital Multimeter

30 μ F Capacitor
29.8 k Ω Resistor

A schematic of the circuit and apparatus which were employed for practicing the Example are illustrated in Figure 1. Referring now to Figure 1, the aforementioned test panels were contacted with a solution comprising 10% sodium mineral and deionized water. A current was passed through the circuit and solution in the manner illustrated in Figure 1. The test panels was exposed for 74 hours under ambient environmental conditions. A visual inspection of the panels indicated that a light-grey colored coating or film was deposited upon the test panel.

In order to ascertain the corrosion protection afforded by the mineral containing coating, the coated panels were tested in accordance with ASTM Procedure No. B117. A section of the panels was covered with tape so that only the coated area was exposed and, thereafter, the taped panels were placed into salt spray. For purposes of comparison, the following panels were also tested in accordance with ASTM Procedure No. B117, 1) Bare Electroplated Panel, and 2) Bare Electroplated Panel soaked for 70 hours in a 10% Sodium Mineral Solution. In addition, bare zinc phosphate coated steel panels(ACT B952, no Parcolene) and bare iron phosphate coated steel panels (B1000, no Parcolene) were subjected to salt spray for reference.

The results of the ASTM Procedure are listed in the Table below:

Panel Description	Hours in B117 Salt Spray
Zinc phosphate coated steel	1
Iron phosphate coated steel	1
Standard Bare Electroplated Panel	\approx 120
Standard Panel with Sodium Mineral Soak	\approx 120
Coated Cathode of the Invention	240+

The above Table illustrates that the instant invention forms a coating or film which imparts markedly improved corrosion resistance. It is also apparent that the process has resulted in a corrosion protective film that lengthens the life of electroplated metal substrates and surfaces.

ESCA analysis was performed on the zinc surface in accordance with conventional techniques and under the following conditions:
Analytical conditions for ESCA:

Instrument

Physical Electronics Model 5701 LSci

X-ray source Monochromatic aluminum
Source power 350 watts
Analysis region 2 mm X 0.8 mm
Exit angle* 50°
Electron acceptance angle $\pm 7^\circ$
Charge neutralization electron flood gun
Charge correction C-(C,H) in C 1s spectra at 284.6 eV

* Exit angle is defined as the angle between the sample plane and the electron analyzer lens.

The silicon photoelectron binding energy was used to characterized the nature of the formed species within the mineralized layer that was formed on the cathode. This species was identified as a zinc disilicate modified by the presence of sodium ion by the binding energy of 102.1 eV for the Si(2p) photoelectron.

EXAMPLE 2

This Example illustrates performing the inventive electrodeposition process at an increased voltage and current in comparison to Example 1. Prior to the electrodeposition, the cathode panel was subjected to preconditioning process:

- 1) 2 minute immersion in a 3:1 dilution of Metal Prep 79 (Parker Amchem),
- 2) two deionized rinse,
- 3) 10 second immersion in a pH 14 sodium hydroxide solution,
- 4) remove excess solution and allow to air dry,
- 5) 5 minute immersion in a 50% hydrogen peroxide solution,
- 6) Blot to remove excess solution and allow to air dry.

A power supply was connected to an electrodeposition cell consisting of a plastic cup containing two standard ACT cold roll steel (clean, unpolished) test panels. One end of the test panel was immersed in a solution consisting of 10% N grade sodium mineral (PQ Corp.) in deionized water. The immersed area (1 side) of each panel was approximately 3 inches by 4 inches (12 sq. in.) for a 1:1 anode to cathode ratio. The panels were connected directly to the DC power supply and a voltage of 6 volts was applied for 1 hour. The resulting current ranged from approximately 0.7-1.9 Amperes. The resultant current density ranged from 0.05-0.16 amps/in².

After the electrolytic process, the coated panel was allowed to dry at ambient conditions and then evaluated for humidity resistance in accordance with ASTM Test No. D2247 by visually monitoring the corrosion activity until

development of red corrosion upon 5% of the panel surface area. The coated test panels lasted 25 hours until the first appearance of red corrosion and 120 hours until 5% red corrosion. In comparison, conventional iron and zinc phosphated steel panels develop first corrosion and 5% red corrosion after 7 hours in ASTM D2247 humidity exposure. The above Examples, therefore, illustrate that the inventive process offers an improvement in corrosion resistance over iron and zinc phosphated steel panels.

EXAMPLE 3

Two lead panels were prepared from commercial lead sheathing and cleaned in 6M HCl for 25 minutes. The cleaned lead panels were subsequently placed in a solution comprising 1 wt.% N-grade sodium silicate (supplied by PQ Corporation).

One lead panel was connected to a DC power supply as the anode and the other was a cathode. A potential of 20 volts was applied initially to produce a current ranging from 0.9 to 1.3 Amperes. After approximately 75 minutes the panels were removed from the sodium silicate solution and rinsed with deionized water.

ESCA analysis was performed on the lead surface. The silicon photoelectron binding energy was used to characterized the nature of the formed species within the mineralized layer. This species was identified as a lead disilicate modified by the presence of sodium ion by the binding energy of 102.0 eV for the Si(2p) photoelectron.

EXAMPLE 4

This Example demonstrates forming a mineral surface upon an aluminum substrate. Using the same apparatus in Example 1, aluminum coupons (3" x 6") were reacted to form the metal silicate surface. Two different alloys of aluminum were used, Al 2024 and Al7075. Prior to the panels being subjected to the electrolytic process, each panel was prepared using the methods outlined below in Table A. Each panel was washed with reagent alcohol to remove any excessive dirt and oils. The panels were either cleaned with Alumiprep 33, subjected to anodic cleaning or both. Both forms of cleaning are designed to remove excess aluminum oxides. Anodic cleaning was accomplished by placing the working panel as an anode into an aqueous solution containing 5% NaOH, 2.4% Na₂CO₃, 2% Na₂SiO₃, 0.6% Na₃PO₄, and applying a potential to maintain a current density of 100mA/cm² across the immersed area of the panel for one minute.

Once the panel was cleaned, it was placed in a 1 liter beaker filled with 800 mL of solution. The baths were prepared using deionized water and the contents are shown in the table below. The panel was attached to the negative lead of a DC power supply by a wire while another panel was attached to the positive lead. The

two panels were spaced 2 inches apart from each other. The potential was set to the voltage shown on the table and the cell was run for one hour.

TABLE A

Example	A	B	C	D	E	F	G	H
Alloy type	2024	2024	2024	7075	7075	7075	7075	7075
Anodic Cleaning	Yes	Yes	No	No	Yes	Yes	No	No
Acid Wash	Yes	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Bath Solution								
Na ₂ SiO ₃	1%	10%	1%	10%	1%	10%	1%	10%
H ₂ O ₂	1%	0%	0%	1%	1%	0%	0%	1%
Potential	12V	18V	12V	18V	12V	18V	12V	18V

ESCA was used to analyze the surface of each of the substrates. Every sample measured showed a mixture of silica and metal silicate. Without wishing to be bound by any theory or explanation, it is believed that the metal silicate is a result of the reaction between the metal cations of the surface and the alkali silicates from the reaction or precipitated silica from the coating removal process. The metal silicate is indicated by a Si (2p) binding energy (BE) in the low 102 eV range, typically between 102.1 to 102.3. The silica can be seen by Si(2p) BE between 103.3 to 103.6 eV. The resulting spectra show overlapping peaks, upon deconvolution reveal binding energies in the ranges representative of metal silicate and silica.

EXAMPLE 5

This Example illustrates an alternative to immersion for creating the silicate containing medium.

An aqueous gel made from 5% sodium silicate and 10% fumed silica was used to coat cold rolled steel panels. One panel was washed with reagent alcohol, while the other panel was washed in a phosphoric acid based metal prep, followed by a sodium hydroxide wash and a hydrogen peroxide bath. The apparatus was set up using a DC power supply connecting the positive lead to the steel panel and the negative lead to a platinum wire wrapped with glass wool. This setup was designed to simulate a brush plating operation. The "brush" was immersed in the gel solution to allow for complete saturation. The potential was set for 12V and the gel was painted onto the panel with the brush. As the brush passed over the

surface of the panel, hydrogen gas evolution could be seen. The gel was brushed on for five minutes and the panel was then washed with DI water to remove any excess gel and unreacted silicates.

ESCA was used to analyze the surface of each steel panel. ESCA detects the reaction products between the metal substrate and the environment created by the electrolytic process. Every sample measured showed a mixture of silica and metal silicate. The metal silicate is a result of the reaction between the metal cations of the surface and the alkali silicates of the coating. The silica is a result of either excess silicates from the reaction or precipitated silica from the coating removal process. The metal silicate is indicated by a Si (2p) binding energy (BE) in the low 102 eV range, typically between 102.1 to 102.3. The silica can be seen by Si(2p) BE between 103.3 to 103.6 eV. The resulting spectra show overlapping peaks, upon deconvolution reveal binding energies in the ranges representative of metal silicate and silica.

EXAMPLE 6

Using the same apparatus in Example 1, cold rolled steel coupons (ACT laboratories) were reacted to form the metal silicate surface. Prior to the panels being subjected to the electrolytic process, each panel was prepared using the methods outlined below in Table B. Each panel was washed with reagent alcohol to remove any excessive dirt and oils. The panels were either cleaned with Metalprep 79 (Parker Archem), subjected to anodic cleaning or both. Both forms of cleaning are designed to remove excess metal oxides. Anodic cleaning was accomplished by placing the working panel as an anode into an aqueous solution containing 5% NaOH, 2.4% Na₂CO₃, 2% Na₂SiO₃, 0.6% Na₃PO₄, and applying a potential to maintain a current density of 100mA/cm² across the immersed area of the panel for one minute.

Once the panel was cleaned, it was placed in a 1 liter beaker filled with 800 mL of solution. The baths were prepared using deionized water and the contents are shown in the table below. The panel was attached to the negative lead of a DC power supply by a wire while another panel was attached to the positive lead. The two panels were spaced 2 inches apart from each other. The potential was set to the voltage shown on the table and the cell was run for one hour.

TABLE B

Example	AA	BB	CC	DD	EE
Substrate type	CRS	CRS	CRS	CRS ¹	CRS ²
Anodic Cleaning	No	Yes	No	No	No
Acid Wash	Yes	Yes	Yes	No	No
Bath Solution					
Na ₂ SiO ₃	1%	10%	1%	-	-

Potential (V)	14-24	6 (CV)	12V (CV)	-
Current Density (mA/cm ²)	23 (CC)	23-10	85-48	-
B177	2hrs	1 hr	1 hr	0.25 hr

1 Cold Rolled Steel Control- No treatment was done to this panel.
2 Cold Rolled Steel with iron phosphate treatment (ACT Laboratories)- No further treatments were performed

The electrolytic process was either run as a constant current or constant voltage experiment, designated by the CV or CC symbol in the table. Constant Voltage experiments applied a constant potential to the cell allowing the current to fluctuate while Constant Current experiments held the current by adjusting the potential. Panels were tested for corrosion protection using ASTM B117. Failures were determined at 5% surface coverage of red rust.

ESCA was used to analyze the surface of each of the substrates. ESCA detects the reaction products between the metal substrate and the environment created by the electrolytic process. Every sample measured showed a mixture of silica and metal silicate. The metal silicate is a result of the reaction between the metal cations of the surface and the alkali silicates of the coating. The silica is a result of either excess silicates from the reaction or precipitated silica from the coating removal process. The metal silicate is indicated by a Si (2p) binding energy (BE) in the low 102 eV range, typically between 102.1 to 102.3. The silica can be seen by Si(2p) BE between 103.3 to 103.6 eV. The resulting spectra show overlapping peaks, upon deconvolution reveal binding energies in the ranges representative of metal silicate and silica.

EXAMPLE 7

Using the same apparatus in Example 1, zinc galvanized steel coupons (EZG 60G ACT Laboratories) were reacted to form the metal silicate surface.

Prior to the panels being subjected to the electrolytic process, each panel was prepared using the methods outlined below in Table C. Each panel was washed with reagent alcohol to remove any excessive dirt and oils.

Once the panel was cleaned, it was placed in a 1 liter beaker filled with 800 mL of solution. The baths were prepared using deionized water and the contents are shown in the table below. The panel was attached to the negative lead of a DC power supply by a wire while another panel was attached to the positive lead. The two panels were spaced approximately 2 inches apart from each other. The

potential was set to the voltage shown on the table and the cell was run for one hour.

TABLE C

Example	A1	B2	C3	D5
Substrate type	GS	GS	GS	GS
Bath Solution				
Na ₂ SiO ₃	10%	1%	10%	-
Potential (V)	6 (CV)	10 (CV)	18 (CV)	-
Current Density	22-3	7-3	142-3	-
(mA/cm ²)				
B177	336 hrs	224 hrs	216 hrs	96 hrs

5

1 Galvanized Steel Control- No treatment was done to this panel.

Panels were tested for corrosion protection using ASTM B117. Failures were determined at 5% surface coverage of red rust.

ESCA was used to analyze the surface of each of the substrates. ESCA detects the reaction products between the metal substrate and the environment created by the electrolytic process. Every sample measured showed a mixture of silica and metal silicate. The metal silicate is a result of the reaction between the metal cations of the surface and the alkali silicates of the coating. The silica is a result of either excess silicates from the reaction or precipitated silica from the coating removal process. The metal silicate is indicated by a Si(2p) binding energy (BE) in the low 102 eV range, typically between 102.1 to 102.3. The silica can be seen by Si(2p) BE between 103.3 to 103.6 eV. The resulting spectra show overlapping peaks, upon deconvolution reveal binding energies in the ranges representative of metal silicate and silica.

EXAMPLE 8

Using the same apparatus in Example 1, copper coupons (C110 Hard, Fullerton Metals) were reacted to form the metal silicate surface. Prior to the panels being subjected to the electrolytic process, each panel was prepared using the methods outlined below in Table D. Each panel was washed with reagent alcohol to remove any excessive dirt and oils.

Once the panel was cleaned, it was placed in a 1 liter beaker filled with 800 mL of solution. The baths were prepared using deionized water and the contents are shown in the table below. The panel was attached to the negative lead of a DC power supply by a wire while another panel was attached to the positive lead. The

13

two panels were spaced 2 inches apart from each other. The potential was set to the voltage shown on the table and the cell was run for one hour.

TABLE D

Example	AA1	BB2	CC3	DD4	EE5
Substrate type	Cu	Cu	Cu	Cu	Cu
Bath Solution					
Na ₂ SiO ₃	10%	10%	1%	1%	-
Potential (V)	12 (CV)	6 (CV)	6 (CV)	36 (CV)	-
Current Density	40-17	19-9	4-1	36-10	-
(mA/cm ²)					
B117	11 hrs	11 hrs	5 hrs	5 hrs	2 hrs

5

1 Copper Control- No treatment was done to this panel.

Panels were tested for corrosion protection using ASTM B117. Failures were determined by the presence of copper oxide which was indicated by the appearance of a dull haze over the surface.

ESCA was used to analyze the surface of each of the substrates. ESCA allows us to examine the reaction products between the metal substrate and the environment set up from the electrolytic process. Every sample measured showed a mixture of silica and metal silicate. The metal silicate is a result of the reaction between the metal cations of the surface and the alkali silicates of the coating. The silica is a result of either excess silicates from the reaction or precipitated silica from the coating removal process. The metal silicate is indicated by a Si(2p) binding energy (BE) in the low 102 eV range, typically between 102.1 to 102.3. The silica can be seen by Si(2p) BE between 103.3 to 103.6 eV. The resulting spectra show overlapping peaks, upon deconvolution reveal binding energies in the ranges representative of metal silicate and silica.

14

1/1

THE FOLLOWING IS CLAIMED:

1. An electrically enhanced method for forming a corrosion resistant surface on a metal surface comprising:
 contacting the metal surface with a silicate containing medium, passing a current through said surface and medium at a rate and period of time sufficient to form a mineral upon the surface wherein said mineral imparts improved corrosion resistance to said surface.
2. A method for improving the corrosion resistance of an electrically conductive surface comprising:
 immersing the metal surface within an alkali silicate containing medium, passing a current through said surface and medium wherein said metal surface reacts with a portion of the metal surface to form a layer having improved corrosion resistance in comparison to the metal surface.
3. A cathodic method for improving the corrosion resistance of metal surface comprising:
 exposing the metal surface to a silicate containing medium, establishing an electrolytic environment wherein the surface is employed as a cathode, passing a current through the silicate medium and the surface for a period of time and under conditions sufficient to form a corrosion resistant surface upon the metal surface.
4. The method of Claim 3 wherein the silicate containing medium comprises sodium silicate.
5. The method of Claim 3 wherein the metal surface comprises at least one member selected from the group consisting of lead, copper, zinc, aluminum and steel.
6. The method of Claim 3 wherein the corrosion resistant surface comprises a reaction product formed between the metal surface and the silicate.
7. The method of Claim 6 wherein the corrosion resistant surface comprises a mineral layer.

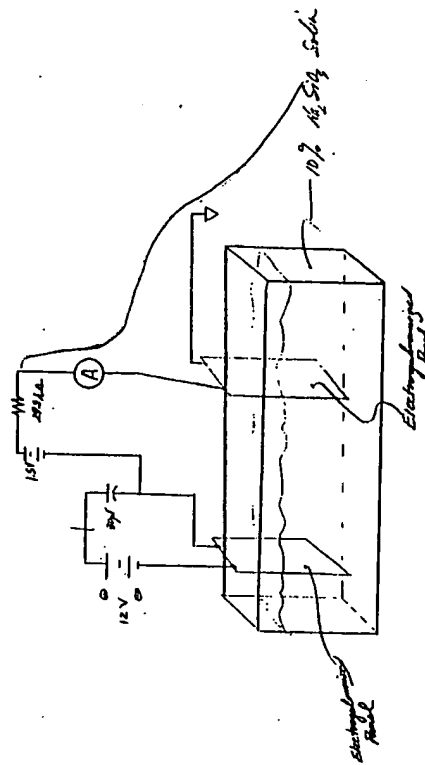


Fig 1

INTERNATIONAL SEARCH REPORT

A. CLASSIFICATION OF SUBJECT MATTER IPC 6 C2509/04		Int. Application No. PCT/US 98/01682
According to International Patent Classification (IPC) or to both national classification and IPC		
B. FIELD SEARCHED Minimum documentation searched (classification system followed by classification symbols) IPC 6 C250		
Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched		
Electronic data base consulted during the international search (name of data base and, where practical, search terms used)		
C. DOCUMENTS CONSIDERED TO BE RELEVANT		
Category *	Classification of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 3 658 662 A (CASSON EDWARD A JR ET AL) 25 April 1972 cited in the application see column 1, line 1-3; claims 1-5	1, 2
X	DATABASE WPI Section Ch. Week 9344 Derwent Publications Ltd., London, GB; Class M1, AN 93-348855 XP002065862 & JP 05 255 889 A (KANASAKI STEEL CORP) see abstract	1-7
* Further documents are listed in the continuation of box C. <input checked="" type="checkbox"/> Patent family members are listed in annex.		
* Special categories of cited documents : "A" document claiming the general state of the art which is not prior art for the purposes of the international search "T" earlier document but published on or after the international filing date "L" document which may throw doubt on priority claim(s) or which is cited to establish the publication date of another document (in the specification) "O" document relating to an oral disclosure, use, exhibition or other means "P" document published prior to the international filing date but later than the priority date claimed "G" document member of the same patent family		
Date of the actual completion of the international search 26 May 1998		Date of mailing of the international search report 05/06/1998
Name and mailing address of the ISA European Patent Office, P.O. Box 1 NL - 2200 HV Rijswijk Tel. (+31-70) 340-5000, Tx. 31 651 apo NL Fax: (+31-70) 340-5010		Authorized officer Van Leeuwen, R

Form PCT/ISA/210 (second sheet) (July 1992)

INTERNATIONAL SEARCH REPORT

Int. Application No. PCT/US 98/01682	
Patent document cited in search report US 3658662 A	Publication date 25-04-1972
Patent family member(s) AT 304216 A BE 743794 A CA 926335 A CH 519586 A DE 2000227 A FR 2028758 A GB 1291771 A NL 7000867 A ZA 7000316 A	Publication date 15-11-1972 28-05-1970 15-05-1973 29-02-1972 30-07-1970 16-10-1970 04-10-1972 23-07-1970 25-08-1971

Form PCT/ISA/210 (first sheet) (July 1992)